



## Film Capacitors

### Metallized Polypropylene Film Capacitors (MFP)

**Series/Type:** B32686S  
**Date:** May 2009

**Snubber**
**Typical applications**

- Snubbing
- Filtering
- IGBT

**Climatic**

- Max. operating temperature: 110 °C
- Climatic category (IEC 60068-1): 55/100/56

**Construction**

- Dielectric: polypropylene (PP)
- Film metallized on one side and metal foils internally connected in series
- Plastic case, epoxy resin sealing (UL 94 V-0)

**Features**

- Very high pulse strength
- High current
- Highest possible contact reliability

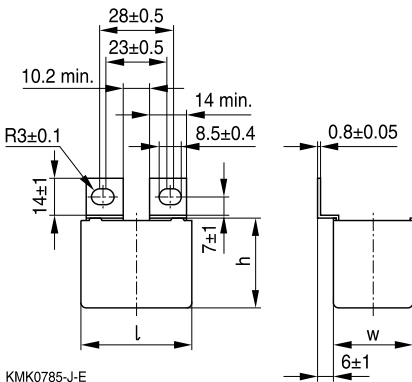
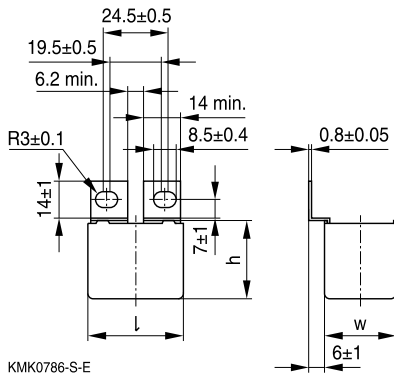
**Terminals**

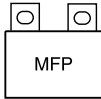
- Strap terminals, tinned copper (max. torque 10 Nm)

**Marking**

Manufacturer's logo, ordering code, style (MFP) rated capacitance (coded), cap. tolerance (code letter), rated DC voltage, date of manufacture (coded)

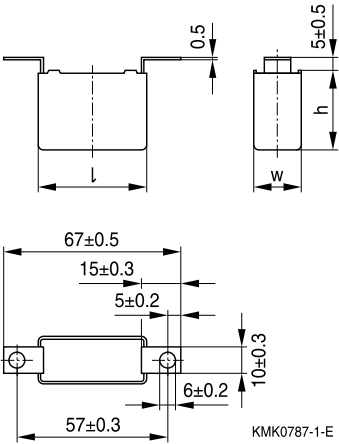
**Delivery mode:** Bulk (untaped)

**Dimensional drawings**
**T1 (code no. 561)**

**T2 (code no. 562)**


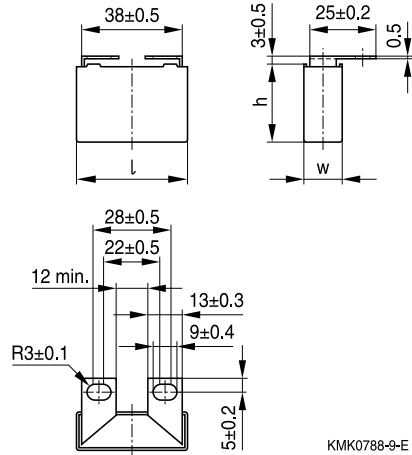


**Dimensional drawings (continued)**

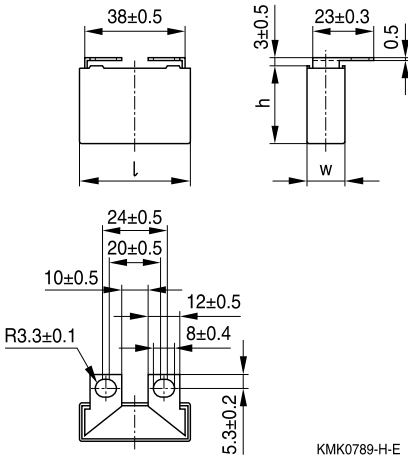
**T3 (code no. 563)**



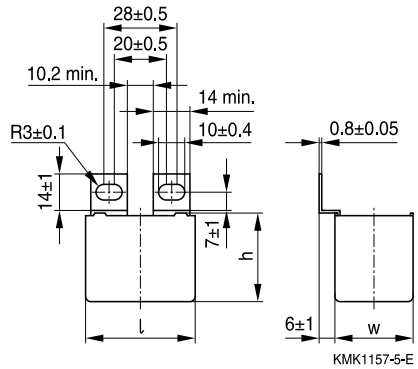
**T4 (code no. 564)**



**T5 (code no. 565)**



**T6 (code no. 566)**





**B32686S**

**Snubber**

**Overview of available types**

Type	B32686S			
$V_R$ (V DC)	1000	1250	1600	2000
$V_{RMS}$ (V AC)	400	450	450	500
$C_R$ (nF)				
22				
33				
47				
68				
100				
120				
150				
220				
270				
330				
390				
470				
560				
680				

**Electrical specifications, ordering codes and packing units**

$V_R$	$V_{RMS}$ $f \leq 1 \text{ kHz}$	$C_R$	Max. dimensions $w \times h \times l$	$I_{RMS}$ 100 kHz	ESR 100 kHz	Ordering code (composition see below)	Ter- minal	pcs./ MOQ
V DC	V AC	nF	mm	A	m $\Omega$			
1000	400	68	12.0 × 22.5 × 42.0	4.0	20	B32686S0683+563	T3	224
		68	12.0 × 22.5 × 42.0	4.0	20	B32686S0683+564	T4	384
		100	12.0 × 22.5 × 42.0	4.5	15	B32686S0104+563	T3	224
		100	12.0 × 22.5 × 42.0	4.5	15	B32686S0104+564	T4	384
		120	12.0 × 22.5 × 42.0	4.5	13	B32686S0124+563	T3	224
		120	12.0 × 22.5 × 42.0	4.5	13	B32686S0124+564	T4	384
		150	14.0 × 25.0 × 42.0	5.5	10	B32686S0154+563	T3	192
		150	14.0 × 25.0 × 42.0	5.5	10	B32686S0154+564	T4	288
		150	14.0 × 25.0 × 42.0	5.5	10	B32686S0154+565	T5	288
		220	16.0 × 28.5 × 42.0	7.0	7	B32686S0224+563	T3	160
		220	16.0 × 28.5 × 42.0	7.0	7	B32686S0224+564	T4	192
		220	16.0 × 28.5 × 42.0	7.0	7	B32686S0224+565	T5	192
		270	18.0 × 32.5 × 42.0	7.5	7	B32686S0274+563	T3	144
		270	18.0 × 32.5 × 42.0	7.5	7	B32686S0274+564	T4	128
		270	18.0 × 32.5 × 42.0	7.5	7	B32686S0274+565	T5	128
		330	20.0 × 39.5 × 42.0	8.5	5	B32686S0334+561	T1	96
		330	20.0 × 39.5 × 42.0	8.5	5	B32686S0334+562	T2	96
		330	20.0 × 39.5 × 42.0	8.5	5	B32686S0334+563	T3	104
		330	20.0 × 39.5 × 42.0	8.5	5	B32686S0334+564	T4	96
		330	20.0 × 39.5 × 42.0	8.5	5	B32686S0334+565	T5	96
		330	20.0 × 39.5 × 42.0	8.5	5	B32686S0334+566	T6	96
		390	20.0 × 39.5 × 42.0	9.0	5	B32686S0394+561	T1	96
		390	20.0 × 39.5 × 42.0	9.0	5	B32686S0394+562	T2	96
		390	20.0 × 39.5 × 42.0	9.0	5	B32686S0394+563	T3	104
		390	20.0 × 39.5 × 42.0	9.0	5	B32686S0394+564	T4	96
		390	20.0 × 39.5 × 42.0	9.0	5	B32686S0394+565	T5	96
		390	20.0 × 39.5 × 42.0	9.0	5	B32686S0394+566	T6	96
		470	28.0 × 37.0 × 42.0	10.0	3	B32686S0474+561	T1	108
		470	28.0 × 37.0 × 42.0	10.0	3	B32686S0474+562	T2	108
		470	28.0 × 37.0 × 42.0	10.0	3	B32686S0474+563	T3	72
		470	28.0 × 37.0 × 42.0	10.0	3	B32686S0474+566	T6	108

MOQ = Minimum Order Quantity, consisting of 4 packing units.

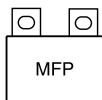
Further E series and intermediate capacitance values on request.

**Composition of ordering code**

+ = Capacitance tolerance code:

K =  $\pm 10\%$

J =  $\pm 5\%$


**B32686S**
**Snubber**
**Electrical specifications, ordering codes and packing units**

$V_R$	$V_{RMS}$ $f \leq 1 \text{ kHz}$	$C_R$	Max. dimensions $w \times h \times l$ mm	$I_{RMS}$ 100 kHz A	ESR 100 kHz $m\Omega$	Ordering code (composition see below)	Ter- minal	pcs./ MOQ
V DC	V AC	nF						
1000	400	560	28.0 × 37.0 × 42.0	11.0	3	B32686S0564+561	T1	108
		560	28.0 × 37.0 × 42.0	11.0	3	B32686S0564+562	T2	108
		560	28.0 × 37.0 × 42.0	11.0	3	B32686S0564+563	T3	72
		560	28.0 × 37.0 × 42.0	11.0	3	B32686S0564+566	T6	108
		680	30.0 × 45.0 × 42.0	12.0	3	B32686S0684+561	T1	48
		680	30.0 × 45.0 × 42.0	12.0	3	B32686S0684+562	T2	48
		680	30.0 × 45.0 × 42.0	12.0	3	B32686S0684+563	T3	72
		680	30.0 × 45.0 × 42.0	12.0	3	B32686S0684+566	T6	48
1250	450	68	12.0 × 22.5 × 42.0	4.5	20	B32686S7683+563	T3	224
		68	12.0 × 22.5 × 42.0	4.5	20	B32686S7683+564	T4	384
		100	14.0 × 25.0 × 42.0	5.0	15	B32686S7104+563	T3	192
		100	14.0 × 25.0 × 42.0	5.0	15	B32686S7104+564	T4	288
		100	14.0 × 25.0 × 42.0	5.0	15	B32686S7104+565	T5	288
		120	14.0 × 25.0 × 42.0	5.5	13	B32686S7124+563	T3	192
		120	14.0 × 25.0 × 42.0	5.5	13	B32686S7124+564	T4	288
		120	14.0 × 25.0 × 42.0	5.5	13	B32686S7124+565	T5	288
		150	16.0 × 28.5 × 42.0	6.5	10	B32686S7154+563	T3	160
		150	16.0 × 28.5 × 42.0	6.5	10	B32686S7154+564	T4	192
		150	16.0 × 28.5 × 42.0	6.5	10	B32686S7154+565	T5	192
		220	18.0 × 32.5 × 42.0	8.5	7	B32686S7224+563	T3	144
		220	18.0 × 32.5 × 42.0	8.5	7	B32686S7224+564	T4	128
		220	18.0 × 32.5 × 42.0	8.5	7	B32686S7224+565	T5	128
		270	20.0 × 39.5 × 42.0	9.0	7	B32686S7274+561	T1	96
		270	20.0 × 39.5 × 42.0	9.0	7	B32686S7274+562	T2	96
		270	20.0 × 39.5 × 42.0	9.0	7	B32686S7274+563	T3	104
		270	20.0 × 39.5 × 42.0	9.0	7	B32686S7274+564	T4	96
		270	20.0 × 39.5 × 42.0	9.0	7	B32686S7274+565	T5	96
		270	20.0 × 39.5 × 42.0	9.0	7	B32686S7274+566	T6	96
330	28.0 × 37.0 × 42.0	10.0	5	B32686S7334+561	T1	108		
330	28.0 × 37.0 × 42.0	10.0	5	B32686S7334+562	T2	108		
330	28.0 × 37.0 × 42.0	10.0	5	B32686S7334+563	T3	72		
330	28.0 × 37.0 × 42.0	10.0	5	B32686S7334+566	T6	108		

MOQ = Minimum Order Quantity, consisting of 4 packing units.

Further E series and intermediate capacitance values on request.

**Composition of ordering code**

+ = Capacitance tolerance code:

K = ±10%

J = ±5%

**Electrical specifications, ordering codes and packing units**

$V_R$	$V_{RMS}$ $f \leq 1 \text{ kHz}$	$C_R$	Max. dimensions $w \times h \times l$ mm	$I_{RMS}$ 100 kHz A	ESR 100 kHz $m\Omega$	Ordering code (composition see below)	Ter- minal	pcs./ MOQ
V DC	V AC	nF						
1250	450	390	28.0 × 37.0 × 42.0	11.0	5	B32686S7394+561	T1	108
		390	28.0 × 37.0 × 42.0	11.0	5	B32686S7394+562	T2	108
		390	28.0 × 37.0 × 42.0	11.0	5	B32686S7394+563	T3	72
		390	28.0 × 37.0 × 42.0	11.0	5	B32686S7394+566	T6	108
		470	30.0 × 45.0 × 42.0	12.0	5	B32686S7474+561	T1	48
		470	30.0 × 45.0 × 42.0	12.0	5	B32686S7474+562	T2	48
		470	30.0 × 45.0 × 42.0	12.0	5	B32686S7474+563	T3	72
		470	30.0 × 45.0 × 42.0	12.0	5	B32686S7474+566	T6	48
1600	450	47	12.0 × 22.5 × 42.0	5.0	30	B32686S1473+563	T3	224
		47	12.0 × 22.5 × 42.0	5.0	30	B32686S1473+564	T4	384
		68	14.0 × 25.0 × 42.0	6.0	20	B32686S1683+563	T3	192
		68	14.0 × 25.0 × 42.0	6.0	20	B32686S1683+564	T4	288
		68	14.0 × 25.0 × 42.0	6.0	20	B32686S1683+565	T5	288
		100	18.0 × 32.5 × 42.0	7.0	15	B32686S1104+563	T3	144
		100	18.0 × 32.5 × 42.0	7.0	15	B32686S1104+564	T4	128
		100	18.0 × 32.5 × 42.0	7.0	15	B32686S1104+565	T5	128
		120	18.0 × 32.5 × 42.0	7.5	13	B32686S1124+563	T3	144
		120	18.0 × 32.5 × 42.0	7.5	13	B32686S1124+564	T4	128
		120	18.0 × 32.5 × 42.0	7.5	13	B32686S1124+565	T5	128
		150	20.0 × 39.5 × 42.0	8.5	10	B32686S1154+561	T1	96
		150	20.0 × 39.5 × 42.0	8.5	10	B32686S1154+562	T2	96
		150	20.0 × 39.5 × 42.0	8.5	10	B32686S1154+563	T3	104
		150	20.0 × 39.5 × 42.0	8.5	10	B32686S1154+564	T4	96
		150	20.0 × 39.5 × 42.0	8.5	10	B32686S1154+565	T5	96
		150	20.0 × 39.5 × 42.0	8.5	10	B32686S1154+566	T6	96
		220	28.0 × 37.0 × 42.0	10.5	7	B32686S1224+561	T1	108
220	28.0 × 37.0 × 42.0	10.5	7	B32686S1224+562	T2	108		
220	28.0 × 37.0 × 42.0	10.5	7	B32686S1224+563	T3	72		
220	28.0 × 37.0 × 42.0	10.5	7	B32686S1224+566	T6	108		

MOQ = Minimum Order Quantity, consisting of 4 packing units.

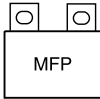
Further E series and intermediate capacitance values on request.

**Composition of ordering code**

+ = Capacitance tolerance code:

K = ±10%

J = ±5%


**B32686S**
**Snubber**
**Electrical specifications, ordering codes and packing units**

$V_R$	$V_{RMS}$ $f \leq 1\text{kHz}$	$C_R$	Max. dimensions $w \times h \times l$ mm	$I_{RMS}$ 100 kHz A	ESR 100 kHz m $\Omega$	Ordering code (composition see below)	Ter- minal	pcs./ MOQ
V DC	V AC	nF						
1600	450	270	30.0 × 45.0 × 42.0	11.5	7	B32686S1274+561	T1	48
		270	30.0 × 45.0 × 42.0	11.5	7	B32686S1274+562	T2	48
		270	30.0 × 45.0 × 42.0	11.5	7	B32686S1274+563	T3	72
		270	30.0 × 45.0 × 42.0	11.5	7	B32686S1274+566	T6	48
2000	500	22	12.0 × 22.5 × 42.0	4.0	70	B32686S2223+563	T3	224
		22	12.0 × 22.5 × 42.0	4.0	70	B32686S2223+564	T4	384
		33	14.0 × 25.0 × 42.0	5.0	50	B32686S2333+563	T3	192
		33	14.0 × 25.0 × 42.0	5.0	50	B32686S2333+564	T4	288
		33	14.0 × 25.0 × 42.0	5.0	50	B32686S2333+565	T5	288
		47	16.0 × 28.5 × 42.0	6.0	30	B32686S2473+563	T3	160
		47	16.0 × 28.5 × 42.0	6.0	30	B32686S2473+564	T4	192
		47	16.0 × 28.5 × 42.0	6.0	30	B32686S2473+565	T5	192
		68	18.0 × 32.5 × 42.0	7.5	20	B32686S2683+563	T3	144
		68	18.0 × 32.5 × 42.0	7.5	20	B32686S2683+564	T4	128
		68	18.0 × 32.5 × 42.0	7.5	20	B32686S2683+565	T5	128
		100	20.0 × 39.5 × 42.0	8.5	15	B32686S2104+561	T1	96
		100	20.0 × 39.5 × 42.0	8.5	15	B32686S2104+562	T2	96
		100	20.0 × 39.5 × 42.0	8.5	15	B32686S2104+563	T3	104
		100	20.0 × 39.5 × 42.0	8.5	15	B32686S2104+564	T4	96
		100	20.0 × 39.5 × 42.0	8.5	15	B32686S2104+565	T5	96
		100	20.0 × 39.5 × 42.0	8.5	15	B32686S2104+566	T6	96
		120	28.0 × 37.0 × 42.0	9.0	13	B32686S2124+561	T1	96
		120	28.0 × 37.0 × 42.0	9.0	13	B32686S2124+562	T2	96
		120	28.0 × 37.0 × 42.0	9.0	13	B32686S2124+563	T3	104
		120	28.0 × 37.0 × 42.0	9.0	13	B32686S2124+566	T6	96
		150	28.0 × 37.0 × 42.0	10.0	10	B32686S2154+561	T1	108
		150	28.0 × 37.0 × 42.0	10.0	10	B32686S2154+562	T2	108
		150	28.0 × 37.0 × 42.0	10.0	10	B32686S2154+563	T3	72
150	28.0 × 37.0 × 42.0	10.0	10	B32686S2154+566	T6	108		

MOQ = Minimum Order Quantity, consisting of 4 packing units.

Further E series and intermediate capacitance values on request.

**Composition of ordering code**

+ = Capacitance tolerance code:

K = ±10%

J = ±5%



**Technical data**

Operating temperature range	Max. operating temperature $T_{op,max}$	+110 °C	
	Upper category temperature $T_{max}$	+100 °C	
	Lower category temperature $T_{min}$	-55 °C	
	Rated temperature $T_R$	+85 °C	
Dissipation factor $\tan \delta$ at 20 °C (upper limit values)	1.0 · 10 <sup>-3</sup> (at 10 kHz)		
	3.0 · 10 <sup>-3</sup> (at 10 kHz)		
Insulation resistance $R_{ins}$ or time constant $\tau = C_R \cdot R_{ins}$ at 20 °C, rel. humidity ≤ 65% (minimum as-delivered values)	$C_R \leq 0.33 \mu F$	$C_R > 0.33 \mu F$	
	100 GΩ	30000 s	
DC test voltage	2.0 · $V_R$ , 2 s		
Category voltage $V_C$ (continuous operation with $V_{DC}$ or $V_{AC}$ at $f \leq 1$ kHz)	$T_A$ (°C)	DC voltage derating	AC voltage derating
	$T_A \leq 85$ $85 < T_A \leq 100$	$V_C = V_R$ $V_C = V_R \cdot (165 - T_A)/80$	$V_{C,RMS} = V_{RMS}$ $V_{C,RMS} = V_{RMS} \cdot (165 - T_A)/80$
Operating voltage $V_{op}$ for short operating periods ( $V_{DC}$ or $V_{AC}$ at $f \leq 1$ kHz)	$T_A$ (°C)	DC voltage (max. hours)	AC voltage (max. hours)
	$T_A \leq 85$ $85 < T_A \leq 100$	$V_{op} = 1.25 \cdot V_C$ (2000 h) $V_{op} = 1.25 \cdot V_C$ (1000 h)	$V_{op} = 1.0 \cdot V_{C,RMS}$ (2000 h) $V_{op} = 1.0 \cdot V_{C,RMS}$ (1000 h)
Damp heat test Limit values after damp heat test	56 days/40 °C/93% relative humidity		
	Capacitance change $ \Delta C/C $	≤ 2%	
	Dissipation factor change $\Delta \tan \delta$	≤ 1.0 · 10 <sup>-3</sup> (at 10 kHz)	
	Insulation resistance $R_{ins}$ or time constant $\tau = C_R \cdot R_{ins}$	≥ 50% of minimum as-delivered values	
Reliability: Failure rate $\lambda$ Service life $t_{SL}$	1 fit (≤ 1 · 10 <sup>-9</sup> /h) at 0.5 · $V_R$ , 40 °C 200 000 h at 1.0 · $V_R$ , 85 °C For conversion to other operating conditions and temperatures, refer to chapter "Quality, 2 Reliability".		
Failure criteria: Total failure	Short circuit or open circuit		
Failure due to variation of parameters	Capacitance change $ \Delta C/C $	> 10%	
	Dissipation factor $\tan \delta$	4 · upper limit value	
	Insulation resistance $R_{ins}$ or time constant $\tau = C_R \cdot R_{ins}$	< 1500 MΩ ( $C_R \leq 0.33 \mu F$ ) < 500 s ( $C_R > 0.33 \mu F$ )	



**B32686S**

**Snubber**

### Pulse handling capability

"dV/dt" represents the maximum permissible voltage change per unit of time for non-sinusoidal voltages, expressed in V/ $\mu$ s.

"k<sub>0</sub>" represents the maximum permissible pulse characteristic of the waveform applied to the capacitor, expressed in V<sup>2</sup>/ $\mu$ s.

*Note:*

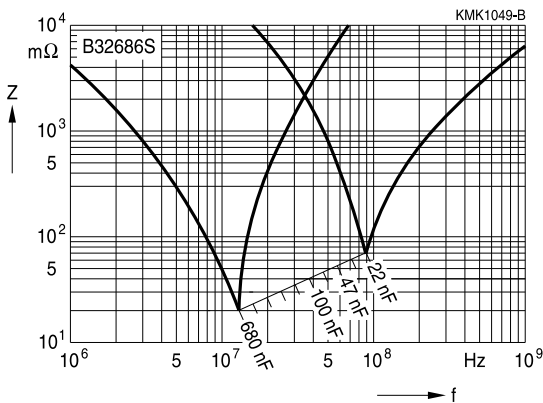
*The values of dV/dt and k<sub>0</sub> provided below must not be exceeded in order to avoid damaging the capacitor.*

### dV/dt and k<sub>0</sub> values

V <sub>R</sub> (V DC)	V <sub>RMS</sub> (V AC)	dV/dt in V/ $\mu$ s	k <sub>0</sub> in V <sup>2</sup> / $\mu$ s
1000	400	2 000	4 000 000
1250	450	2 800	7 000 000
1600	450	3 500	11 000 000
2000	500	4 500	18 000 000

### Impedance Z versus frequency f

(typical values)

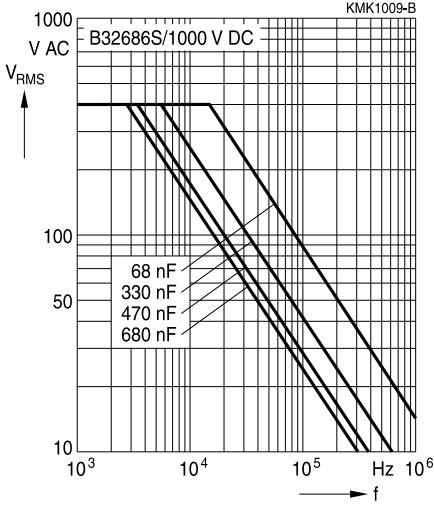




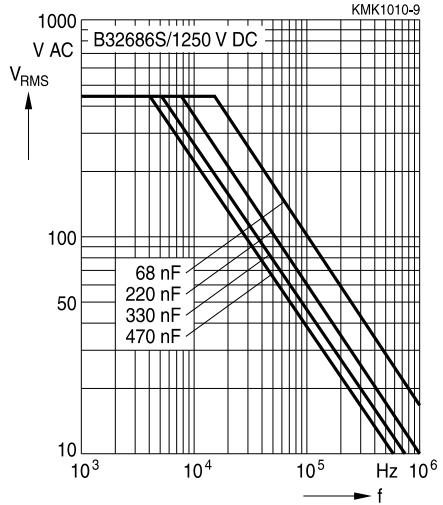
**Permissible AC voltage  $V_{RMS}$  versus frequency  $f$  (for sinusoidal waveforms,  $T_A \leq 90^\circ C$ )**

For  $T_A > 90^\circ C$ , please refer to "General technical information", section 3.2.3.

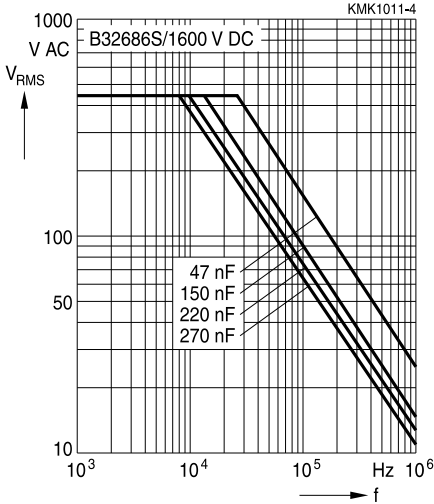
1000 V DC/400 V AC



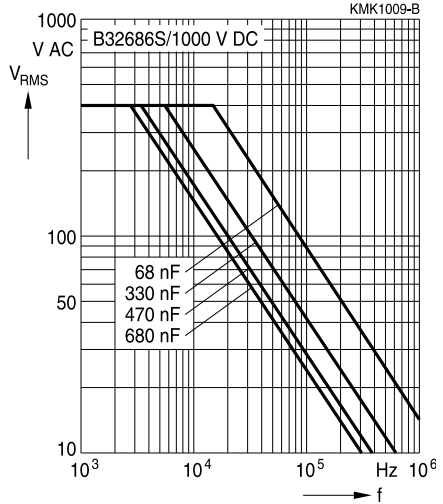
1250 V DC/450 V AC

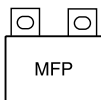


1600 V DC/450 V AC



2000 V DC/500 V AC





**B32686S**

**Snubber**

## Mounting guidelines

### 1 Soldering

#### 1.1 Solderability of leads

The solderability of terminal leads is tested to IEC 60068-2-20, test Ta, method 1.

Before a solderability test is carried out, terminals are subjected to accelerated ageing (to IEC 60068-2-2, test Ba: 4 h exposure to dry heat at 155 °C). Since the ageing temperature is far higher than the upper category temperature of the capacitors, the terminal wires should be cut off from the capacitor before the ageing procedure to prevent the solderability being impaired by the products of any capacitor decomposition that might occur.

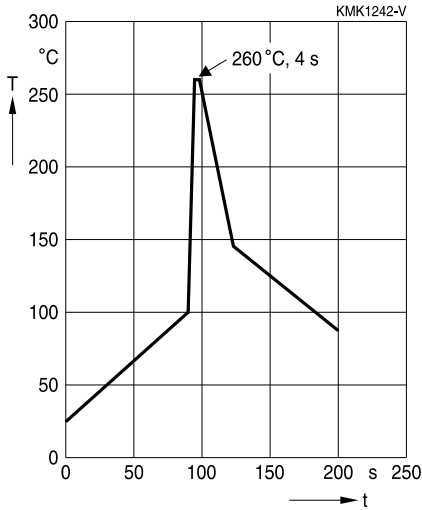
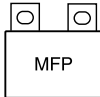
Solder bath temperature	235 ±5 °C
Soldering time	2.0 ±0.5 s
Immersion depth	2.0 +0/−0.5 mm from capacitor body or seating plane
Evaluation criteria:	
Visual inspection	Wetting of wire surface by new solder ≥90%, free-flowing solder

#### 1.2 Resistance to soldering heat

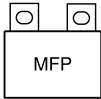
Resistance to soldering heat is tested to IEC 60068-2-20, test Tb, method 1A.

Conditions:

Series	Solder bath temperature	Soldering time
MKT boxed (except 2.5 × 6.5 × 7.2 mm) coated uncoated (lead spacing > 10 mm)	260 ±5 °C	10 ±1 s
MFP MKP (lead spacing > 7.5 mm)		
MKT boxed (case 2.5 × 6.5 × 7.2 mm)		5 ±1 s
MKP (lead spacing ≤ 7.5 mm) MKT uncoated (lead spacing ≤ 10 mm) insulated (B32559)		< 4 s recommended soldering profile for MKT uncoated (lead spacing ≤ 10 mm) and insulated (B32559)



Immersion depth	2.0 +0/−0.5 mm from capacitor body or seating plane
Shield	Heat-absorbing board, (1.5 ±0.5) mm thick, between capacitor body and liquid solder
Evaluation criteria:	
Visual inspection	No visible damage
$\Delta C/C_0$	2% for MKT/MKP/MFP 5% for EMI suppression capacitors
$\tan \delta$	As specified in sectional specification



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### 1.3 General notes on soldering

Permissible heat exposure loads on film capacitors are primarily characterized by the upper category temperature  $T_{max}$ . Long exposure to temperatures above this type-related temperature limit can lead to changes in the plastic dielectric and thus change irreversibly a capacitor's electrical characteristics. For short exposures (as in practical soldering processes) the heat load (and thus the possible effects on a capacitor) will also depend on other factors like:

- Pre-heating temperature and time
- Forced cooling immediately after soldering
- Terminal characteristics:
  - diameter, length, thermal resistance, special configurations (e.g. crimping)
- Height of capacitor above solder bath
- Shadowing by neighboring components
- Additional heating due to heat dissipation by neighboring components
- Use of solder-resist coatings

The overheating associated with some of these factors can usually be reduced by suitable countermeasures. For example, if a pre-heating step cannot be avoided, an additional or reinforced cooling process may possibly have to be included.

EPCOS recommends the following conditions:

- Pre-heating with a maximum temperature of 110 °C
- Temperature inside the capacitor should not exceed the following limits:
  - MKP/MFP 110 °C
  - MKT 160 °C
- When SMD components are used together with leaded ones, the leaded film capacitors should not pass into the SMD adhesive curing oven. The leaded components should be assembled after the SMD curing step.
- Leaded film capacitors are not suitable for reflow soldering.

#### Uncoated capacitors

For uncoated MKT capacitors with lead spacings  $\leq 10$  mm (B32560/B32561) the following measures are recommended:

- pre-heating to not more than 110 °C in the preheater phase
- rapid cooling after soldering



## 2 Cleaning

To determine whether the following solvents, often used to remove flux residues and other substances, are suitable for the capacitors described, refer to the table below:

Type	Ethanol, isopropanol, n-propanol	n-propanol-water mixtures, water with surface tension-reducing tensides (neutral)	Solvent from table A (see next page)	Solvent from table B (see next page)
MKT (uncoated)	Suitable	Unsuitable	In part suitable	Unsuitable
MKT, MKP, MFP (coated/boxed)		Suitable	Suitable	

Even when suitable solvents are used, a reversible change of the electrical characteristics may occur in uncoated capacitors immediately after they are washed. Thus it is always recommended to dry the components (e.g. 4 h at 70 °C) before they are subjected to subsequent electrical testing.

### Table A

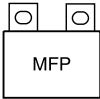
Manufacturers' designations for trifluoro-trichloro-ethane-based cleaning solvents (selection)

Trifluoro-trichloro-ethane	Mixtures of trifluoro-trichloro-ethane with ethanol and isopropanol	Manufacturer
Freon TF	Freon TE 35; Freon TP 35; Freon TES	Du Pont
Frigen 113 TR	Frigen 113 TR-E; Frigen 113 TR-P; Frigen TR-E 35	Hoechst
Arklone P	Arklone A; Arklone L; Arklone K	ICI
Kaltron 113 MDR	Kaltron 113 MDA; Kaltron 113 MDI; Kaltron 113 MDI 35	Kali-Chemie
Flugene 113	Flugene 113 E; Flugene 113 IPA	Rhone-Progil

### Table B (worldwide banned substances)

Manufacturers' designations for unsuitable cleaning solvents (selection)

Mixtures of chlorinated hydrocarbons and ketones with fluorated hydrocarbons	Manufacturer
Freon TMC; Freon TA; Freon TC	Du Pont
Arklone E	ICI
Kaltron 113 MDD; Kaltron 113 MDK	Kali-Chemie
Flugene 113 CM	Rhone-Progil



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### 3 Embedding of capacitors in finished assemblies

In many applications, finished circuit assemblies are embedded in plastic resins. In this case, both chemical and thermal influences of the embedding ("potting") and curing processes must be taken into account.

Our experience has shown that the following potting materials can be recommended: non-flexible epoxy resins with acid-anhydride hardeners; chemically inert, non-conducting fillers; maximum curing temperature of 100 °C.

**Caution:**

Consult us first if you wish to embed uncoated types!





### Cautions and warnings

- Do not exceed the upper category temperature (UCT).
- Do not apply any mechanical stress to the capacitor terminals.
- Avoid any compressive, tensile or flexural stress.
- Do not move the capacitor after it has been soldered to the PC board.
- Do not pick up the PC board by the soldered capacitor.
- Do not place the capacitor on a PC board whose PTH hole spacing differs from the specified lead spacing.
- Do not exceed the specified time or temperature limits during soldering.
- Avoid external energy inputs, such as fire or electricity.
- Avoid overload of the capacitors.

The table below summarizes the safety instructions that must always be observed. A detailed description can be found in the relevant sections of the chapters "General technical information" and "Mounting guidelines".

Topic	Safety information	Reference chapter "General technical information"
Storage conditions	Make sure that capacitors are stored within the specified range of time, temperature and humidity conditions.	4.5 "Storage conditions"
Flammability	Avoid external energy, such as fire or electricity (passive flammability), avoid overload of the capacitors (active flammability) and consider the flammability of materials.	5.3 "Flammability"
Resistance to vibration	Do not exceed the tested ability to withstand vibration. The capacitors are tested to IEC 60068-2-6. EPCOS offers film capacitors specially designed for operation under more severe vibration regimes such as those found in automotive applications. Consult our catalog "Film Capacitors for Automotive Electronics".	5.2 "Resistance to vibration"



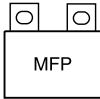
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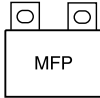
Topic	Safety information	Reference chapter "Mounting guidelines"
Soldering	Do not exceed the specified time or temperature limits during soldering.	1 "Soldering"
Cleaning	Use only suitable solvents for cleaning capacitors.	2 "Cleaning"
Embedding of capacitors in finished assemblies	When embedding finished circuit assemblies in plastic resins, chemical and thermal influences must be taken into account. Caution: Consult us first, if you also wish to embed other uncoated component types!	3 "Embedding of capacitors in finished assemblies"

**Symbols and terms**

Symbol	English	German
$\alpha$	Heat transfer coefficient	Wärmeübergangszahl
$\alpha_C$	Temperature coefficient of capacitance	Temperaturkoeffizient der Kapazität
A	Capacitor surface area	Kondensatoroberfläche
$\beta_C$	Humidity coefficient of capacitance	Feuchtekoeffizient der Kapazität
C	Capacitance	Kapazität
$C_R$	Rated capacitance	Nennkapazität
$\Delta C$	Absolute capacitance change	Absolute Kapazitätsänderung
$\Delta C/C$	Relative capacitance change (relative deviation of actual value)	Relative Kapazitätsänderung (relative Abweichung vom Ist-Wert)
$\Delta C/C_R$	Capacitance tolerance (relative deviation from rated capacitance)	Kapazitätstoleranz (relative Abweichung vom Nennwert)
dt	Time differential	Differentielle Zeit
$\Delta t$	Time interval	Zeitintervall
$\Delta T$	Absolute temperature change (self-heating)	Absolute Temperaturänderung (Selbsterwärmung)
$\Delta \tan \delta$	Absolute change of dissipation factor	Absolute Änderung des Verlustfaktors
$\Delta V$	Absolute voltage change	Absolute Spannungsänderung
dV/dt	Time differential of voltage function (rate of voltage rise)	Differentielle Spannungsänderung (Spannungsflankensteilheit)
$\Delta V/\Delta t$	Voltage change per time interval	Spannungsänderung pro Zeitintervall
E	Activation energy for diffusion	Aktivierungsenergie zur Diffusion
ESL	Self-inductance	Eigeninduktivität
ESR	Equivalent series resistance	Ersatz-Serienwiderstand
f	Frequency	Frequenz
$f_1$	Frequency limit for reducing permissible AC voltage due to thermal limits	Grenzfrequenz für thermisch bedingte Reduzierung der zulässigen Wechselspannung
$f_2$	Frequency limit for reducing permissible AC voltage due to current limit	Grenzfrequenz für strombedingte Reduzierung der zulässigen Wechselspannung
$f_r$	Resonant frequency	Resonanzfrequenz
$F_D$	Thermal acceleration factor for diffusion	Therm. Beschleunigungsfaktor zur Diffusion
$F_T$	Derating factor	Deratingfaktor
i	Current (peak)	Stromspitze
$I_C$	Category current (max. continuous current)	Kategoriestrom (max. Dauerstrom)


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Symbol	English	German
$I_{RMS}$	(Sinusoidal) alternating current, root-mean-square value	(Sinusförmiger) Wechselstrom
$i_z$	Capacitance drift	Inkonstanz der Kapazität
$k_0$	Pulse characteristic	Impuls Kennwert
$L_S$	Series inductance	Serieninduktivität
$\lambda$	Failure rate	Ausfallrate
$\lambda_0$	Constant failure rate during useful service life	Konstante Ausfallrate in der Nutzungsphase
$\lambda_{test}$	Failure rate, determined by tests	Experimentell ermittelte Ausfallrate
$P_{diss}$	Dissipated power	Abgegebene Verlustleistung
$P_{gen}$	Generated power	Erzeugte Verlustleistung
$Q$	Heat energy	Wärmeenergie
$\rho$	Density of water vapor in air	Dichte von Wasserdampf in Luft
$R$	Universal molar constant for gases	Allg. Molarkonstante für Gas
$R$	Ohmic resistance of discharge circuit	Ohmscher Widerstand des Entladekreises
$R_i$	Internal resistance	Innenwiderstand
$R_{ins}$	Insulation resistance	Isolationswiderstand
$R_P$	Parallel resistance	Parallelwiderstand
$R_S$	Series resistance	Serienwiderstand
$S$	severity (humidity test)	Schärfegrad (Feuchtest)
$t$	Time	Zeit
$T$	Temperature	Temperatur
$\tau$	Time constant	Zeitkonstante
$\tan \delta$	Dissipation factor	Verlustfaktor
$\tan \delta_D$	Dielectric component of dissipation factor	Dielektrischer Anteil des Verlustfaktors
$\tan \delta_P$	Parallel component of dissipation factor	Parallelanteil des Verlustfaktors
$\tan \delta_S$	Series component of dissipation factor	Serienanteil des Verlustfaktors
$T_A$	Ambient temperature	Umgebungstemperatur
$T_{max}$	Upper category temperature	Obere Kategorietemperatur
$T_{min}$	Lower category temperature	Untere Kategorietemperatur
$t_{OL}$	Operating life at operating temperature and voltage	Betriebszeit bei Betriebstemperatur und -spannung
$T_{op}$	Operating temperature	Betriebstemperatur
$T_R$	Rated temperature	Nenntemperatur
$T_{ref}$	Reference temperature	Referenztemperatur
$t_{SL}$	Reference service life	Referenz-Lebensdauer
$V_{AC}$	AC voltage	Wechselspannung



Symbol	English	German
$V_C$	Category voltage	Kategoriespannung
$V_{C,RMS}$	Category AC voltage	(Sinusförmige) Kategorie-Wechselspannung
$V_{CD}$	Corona-discharge onset voltage	Teilentlade-Einsatzspannung
$V_{ch}$	Charging voltage	Ladespannung
$V_{DC}$	DC voltage	Gleichspannung
$V_{FB}$	Fly-back capacitor voltage	Spannung (Flyback)
$V_i$	Input voltage	Eingangsspannung
$V_o$	Output voltage	Ausgangssspannung
$V_{op}$	Operating voltage	Betriebsspannung
$V_p$	Peak pulse voltage	Impuls-Spitzenspannung
$V_{pp}$	Peak-to-peak voltage Impedance	Spannungshub
$V_R$	Rated voltage	Nennspannung
$\hat{V}_R$	Amplitude of rated AC voltage	Amplitude der Nenn-Wechselspannung
$V_{RMS}$	(Sinusoidal) alternating voltage, root-mean-square value	(Sinusförmige) Wechselspannung
$V_{SC}$	S-correction voltage	Spannung bei Anwendung "S-correction"
$V_{sn}$	Snubber capacitor voltage	Spannung bei Anwendung "Beschaltung"
$Z$	Impedance	Scheinwiderstand
$e$	Lead spacing	Rastermaß

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